Maplesemi

SLM80N04T

SLM80N04T
40V N -Channel MOSFET

LEAD FREE Pb RoHS

General Description

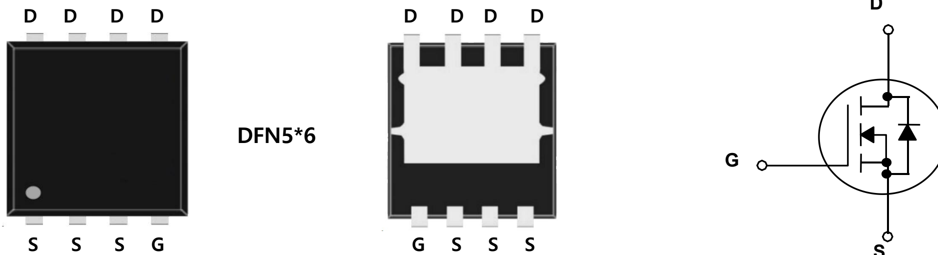
This Power MOSFET is produced using Maple semi's advanced planar stripeTRENCH technology.
This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

Features

- N-Channel:40V 80A
  $R_{DS(on)Typ}$= 4.0mΩ@V_{GS} = 10 V
  $R_{DS(on))Typ}$= 6.5mΩ@V_{GS} = 4..5V
- Very Low On-resistance RDS(ON)
- LowCrss
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

Application

- PWM Application
- Load Switch
- Power Management



Absolute Maximum Ratings

T_C = 25°C unless otherwise noted

Symbol	Parameter	SLM80N04T	Units
V_{DSS}	Drain-Source Voltage	40	V
I_D	Drain Current - Continuous (T_C = 25℃)	80	A
	- Continuous (T_C = 100℃)	52	A
I_{DM}	Drain Current - Pulsed (Note 1)	320	A
V_{GSS}	Gate-Source Voltage	±20	V
E_{AS}	Single Pulsed Avalanche Energy	104	mJ
P_D	Power Dissipation (T_C = 25℃)	77	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.95	W/℃
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	℃
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	℃

* Drain current limited by maximum junction temperature.

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Electrical Characteristics

T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units

Off Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 uA	40	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} =40 V, V_{GS} = 0 V	--	--	1	uA
I_{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 20V, V_{DS} = 0 V	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -20 V, V_{DS} = 0 V	--	--	-100	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 uA	1.0	1.5	2.5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = 10 V, I_D = 30A	--	4.0	5.5	mΩ
		V_{GS} = 4.5 V, I_D = 20A	-	6.5	10	

Dynamic Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
C_{iss}	Input Capacitance	V_{DS} = 20 V, V_{GS} = 0 V, f = 1.0 MHz	--	3042	-	pF
C_{oss}	Output Capacitance		--	386	-	pF
C_{rss}	Reverse Transfer Capacitance		--	232	-	pF

Switching Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$t_{d(on)}$	Turn-On Delay Time	V_{GS}= 10 V, V_{DS}=20 V, R_G = 3 Ω ,I_D=30A	--	8	--	ns
t_r	Turn-On Rise Time		--	18	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	24	--	ns
t_f	Turn-Off Fall Time		--	14	--	ns
Q_g	Total Gate Charge	V_{DS} = 20V, I_D =30A, V_{GS} = 10V	--	57	--	nC
Q_{gs}	Gate-Source Charge		--	9	--	nC
Q_{gd}	Gate-Drain Charge		--	11	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Min	Typ	Max	Units
I_S	Maximum Continuous Drain-Source Diode Forward Current	--	--	80	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	320	A
V_{SD}	Drain to Source Diode Forward Voltage,V GS = 0V, I_{SD} =30A,T J = 25℃	--	--	1.2	V
t_{rr}	Body Diode Reverse Recovery Time T_J =25℃ I_F =20A,dI/dt=100A/μs	--	22	--	nS
Q_{rr}	Body Diode Reverse Recovery Charge T_J =25℃ I_F =20A,dI/dt=100A/μs	--	11	--	nC

Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition: T J =25℃, V DD =20V, V_G =10V, R_G =25Ω, L=0.5mH, I AS =20.4A
3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%

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N- Channel Typical Characteristics

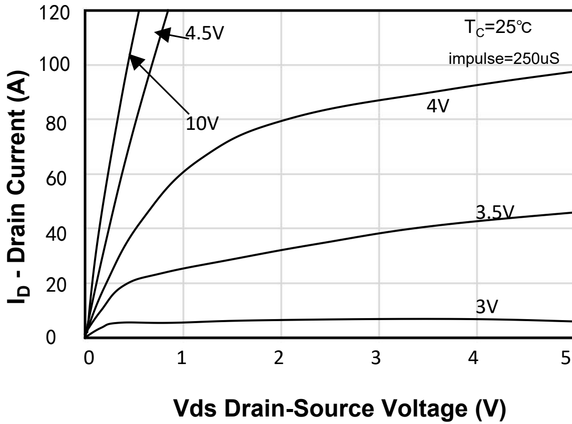

Figure 1. On-Region Characteristics

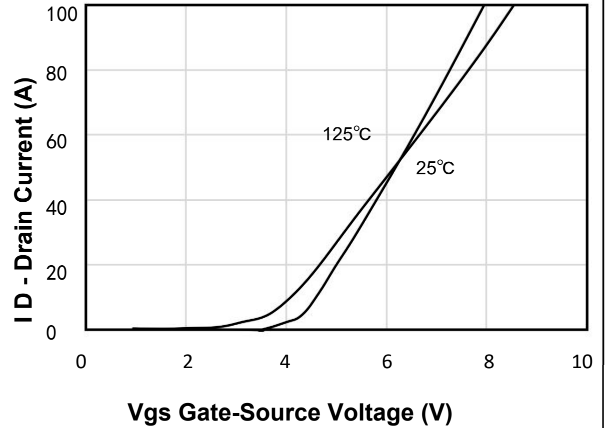

Figure 2. Transfer Characteristics

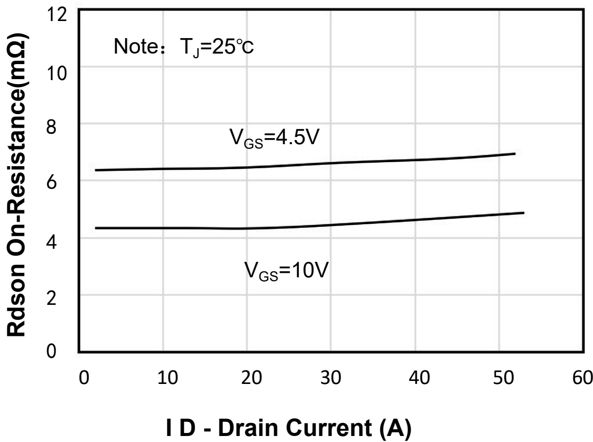

Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

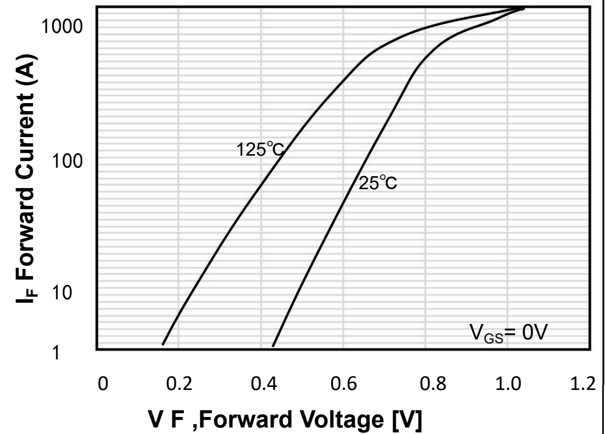

Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

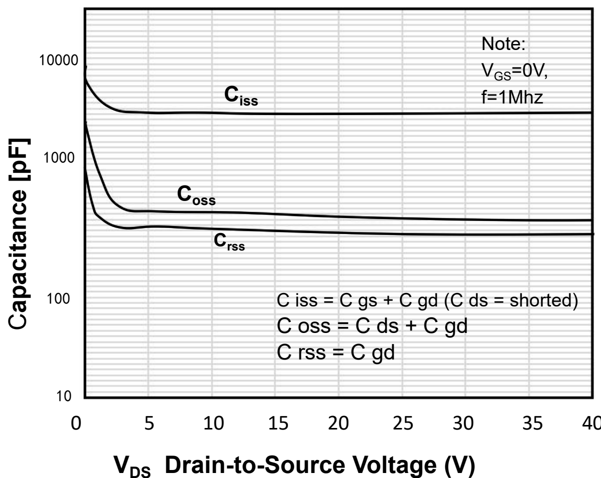

Figure 5. Capacitance Characteristics

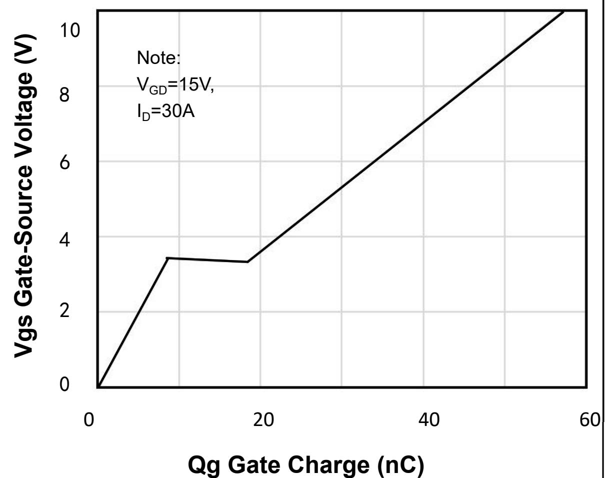

Figure 6. Gate Charge Characteristics

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N- Channel Typical Characteristics (Continued)

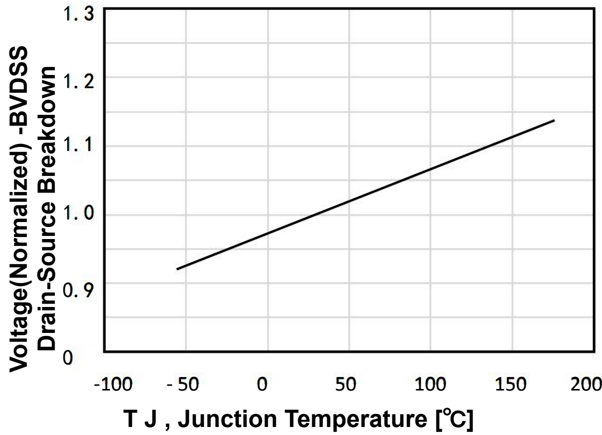

Figure 7. Breakdown Voltage Variation vs Temperature

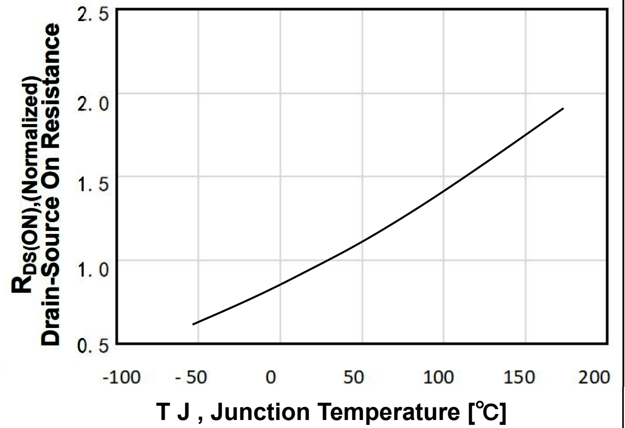

Figure 8. On-Resistance Variation vs Temperature

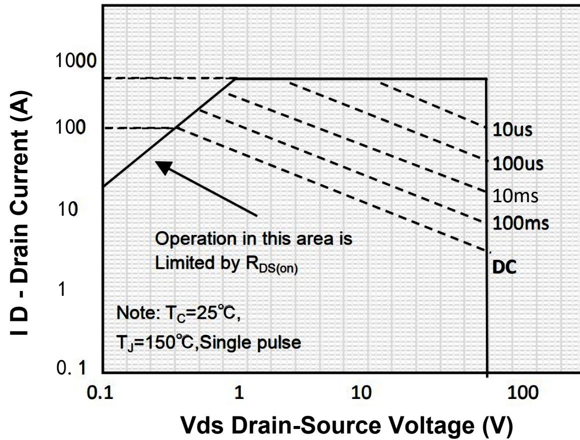

Figure 9. Maximum Safe Operating Area

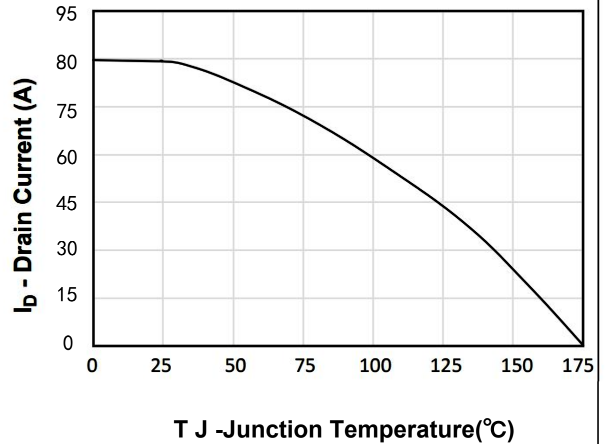

Figure 10. Maximum PContinuous Drain Currentvs Case Temperature

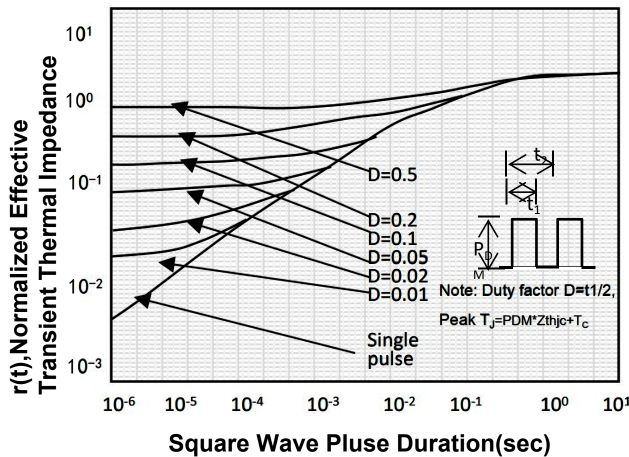

Figure 11. Transient Thermal Response Curve

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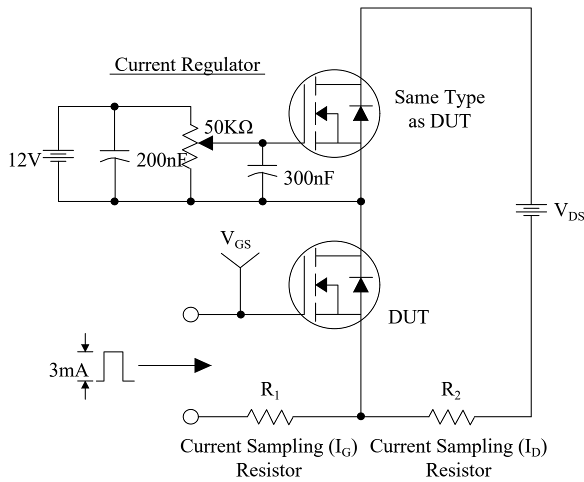
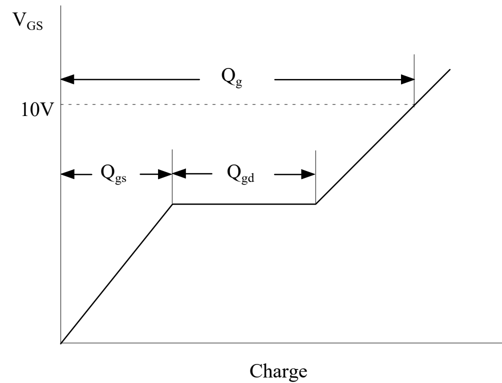
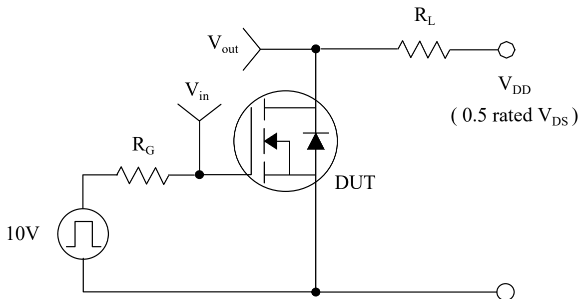
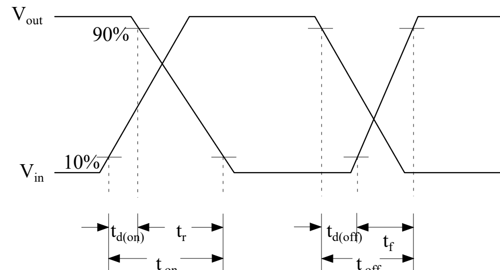
Gate Charge Test Circuit & Waveform



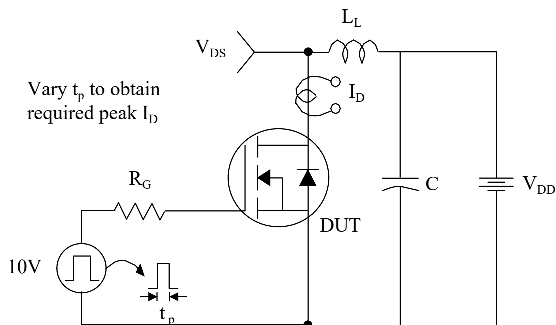


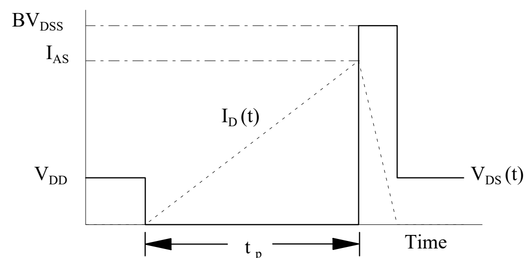
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching Test Circuit & Waveforms





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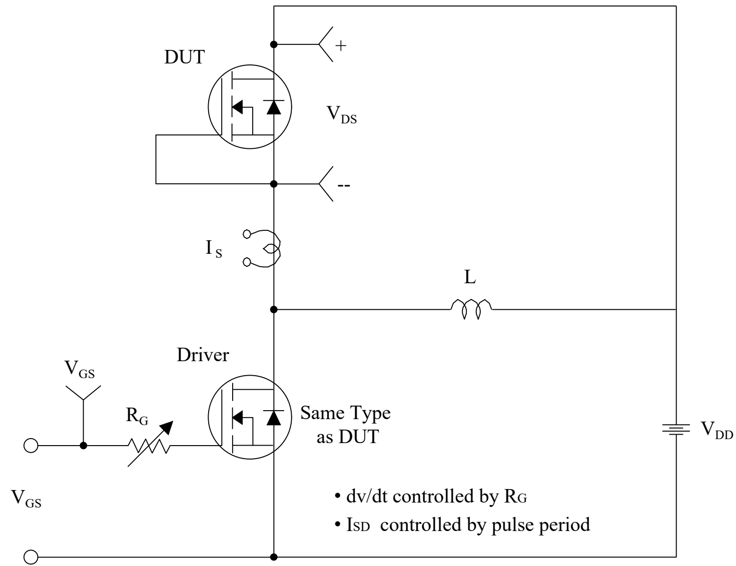
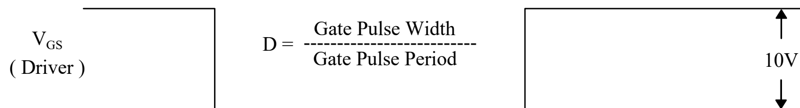
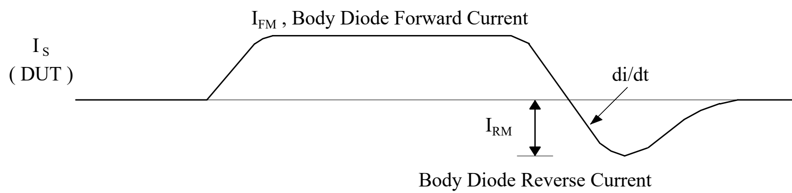
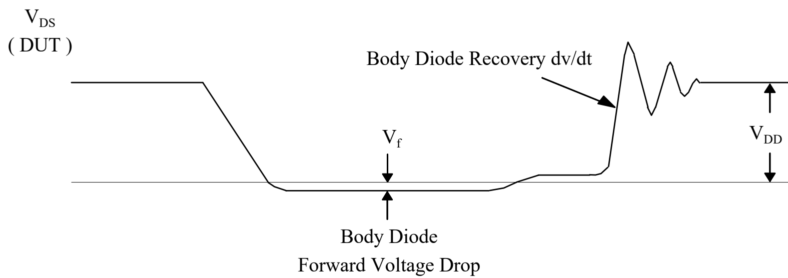
Peak Diode Recovery dv/dt Test Circuit & Waveforms









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